

Molding Type Module IGBT, 2 in 1 Package, 1200 V, 50 A


INT-A-PAK

FEATURES

- Low $V_{CE(on)}$ trench IGBT technology
- Low switching losses
- 10 μ s short circuit capability
- $V_{CE(on)}$ with positive temperature coefficient
- Maximum junction temperature 175 °C
- Low inductance case
- Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

PRIMARY CHARACTERISTICS

V_{CES}	1200 V
I_C at $T_C = 80\text{ °C}$	50 A
$V_{CE(on)}$ (typical) at $I_C = 50\text{ A}$, 25 °C	1.65 V
Speed	8 kHz to 30 kHz
Package	INT-A-PAK
Circuit configuration	Half bridge

TYPICAL APPLICATIONS

- UPS (Uninterruptable Power Supply)
- Electronic welders
- Switching mode power supplies

DESCRIPTION

Vishay's IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. It is designed for applications such as UPS and SMPS.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25\text{ °C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter voltage	V_{CES}		1200	V
Gate to emitter voltage	V_{GES}		± 20	
Collector current	I_C	$T_C = 25\text{ °C}$	100	A
		$T_C = 80\text{ °C}$	50	
Pulsed collector current	$I_{CM}^{(1)}$	$t_p = 1\text{ ms}$	100	
Diode continuous forward current	I_F		50	
Diode maximum forward current	$I_{FM}^{(1)}$		100	
Maximum power dissipation	P_D	$T_J = 175\text{ °C}$	405	W
RMS isolation voltage	V_{ISOL}	$f = 50\text{ Hz}$, $t = 1\text{ min}$	2500	V

Note

(1) Repetitive rating; pulse width limited by maximum junction temperature

IGBT ELECTRICAL SPECIFICATIONS ($T_C = 25\text{ °C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	$V_{(BR)CES}$	$T_J = 25\text{ °C}$	1200	-	-	V
Collector to emitter voltage	$V_{CE(on)}$	$V_{GE} = 15\text{ V}$, $I_C = 50\text{ A}$, $T_J = 25\text{ °C}$	-	1.90	2.35	
		$V_{GE} = 15\text{ V}$, $I_C = 50\text{ A}$, $T_J = 175\text{ °C}$	-	2.50	-	
Gate to emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$, $I_C = 1.4\text{ mA}$, $T_J = 25\text{ °C}$	5.0	5.5	7.5	
Collector cut-off current	I_{CES}	$V_{CE} = V_{CES}$, $V_{GE} = 0\text{ V}$, $T_J = 25\text{ °C}$	-	-	5.0	mA
Gate to emitter leakage current	I_{GES}	$V_{GE} = V_{GES}$, $V_{CE} = 0\text{ V}$, $T_J = 25\text{ °C}$	-	-	400	nA

**SWITCHING CHARACTERISTICS**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600\text{ V}$, $I_C = 50\text{ A}$, $R_g = 15\ \Omega$, $V_{GE} = \pm 15\text{ V}$, $T_J = 25\text{ }^\circ\text{C}$	-	148	-	ns
Rise time	t_r		-	84	-	
Turn-off delay time	$t_{d(off)}$		-	245	-	
Fall time	t_f		-	251	-	
Turn-on switching loss	E_{on}		-	5.51	-	mJ
Turn-off switching loss	E_{off}		-	2.70	-	
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600\text{ V}$, $I_C = 50\text{ A}$, $R_g = 15\ \Omega$, $V_{GE} = \pm 15\text{ V}$, $T_J = 125\text{ }^\circ\text{C}$	-	263	-	ns
Rise time	t_r		-	81	-	
Turn-off delay time	$t_{d(off)}$		-	256	-	
Fall time	t_f		-	292	-	
Turn-on switching loss	E_{on}		-	6.63	-	mJ
Turn-off switching loss	E_{off}		-	3.25	-	
Input capacitance	C_{ies}	$V_{GE} = 0\text{ V}$, $V_{CE} = 30\text{ V}$, $f = 1.0\text{ MHz}$	-	6.24	-	nF
Output capacitance	C_{oes}		-	0.23	-	
Reverse transfer capacitance	C_{res}		-	0.15	-	
SC data	I_{SC}	$t_p \leq 10\ \mu\text{s}$, $V_{GE} = 15\text{ V}$, $T_J = 125\text{ }^\circ\text{C}$, $V_{CC} = 600\text{ V}$, $V_{CEM} \leq 1200\text{ V}$	-	450	-	A
Stray inductance	L_{CE}		-	-	30	nH
Module lead resistance, terminal to chip	$R_{CC'+EE'}$		-	0.75	-	m Ω

DIODE ELECTRICAL SPECIFICATIONS ($T_C = 25\text{ }^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Forward voltage	V _F	I _F = 50 A	T _J = 25 °C	-	1.85	2.25	V
			T _J = 125 °C	-	1.95	-	
Reverse recovery charge	Q _{rr}	I _F = 50 A, V _R = 600 V, dI _F /dt = -654 A/μs V _{GE} = -15 V	T _J = 25 °C	-	3.1	-	μC
			T _J = 125 °C	-	6.1	-	
Peak reverse recovery current	I _{rr}		T _J = 25 °C	-	24	-	A
			T _J = 125 °C	-	31	-	
Reverse recovery energy	E _{rec}		T _J = 25 °C	-	0.98	-	mJ
			T _J = 125 °C	-	2.06	-	

THERMAL AND MECHANICAL SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating junction temperature	T _J		-	-	175	°C
Storage temperature range	T _{Stg}		-40	-	125	°C
Junction to case	R _{thJC}		-	-	0.37	K/W
IGBT			-	-	0.49	
Diode			-	-	0.49	
Case to sink (conductive grease applied)	R _{thCS}		-	0.05	-	
Mounting torque		Power terminal screw: M5	2.5 to 5.0			Nm
		Mounting screw: M6	3.0 to 5.0			
Weight		Weight of module	-	150	-	g

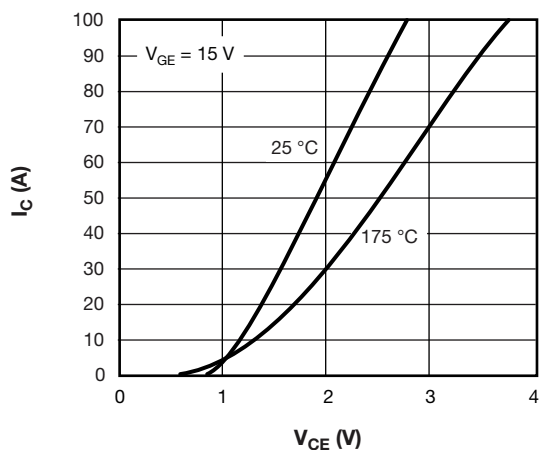


Fig. 1 - IGBT Typical Output Characteristics

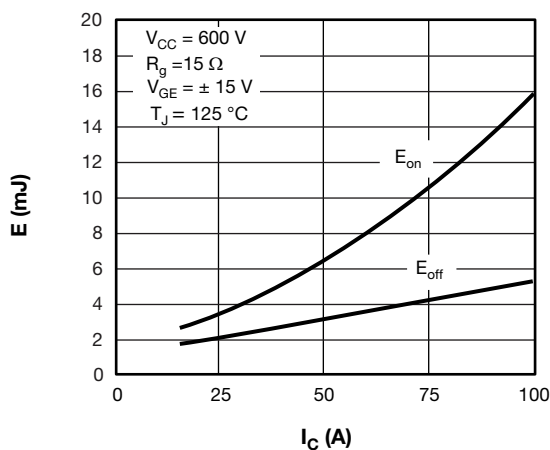


Fig. 3 - IGBT Switching Loss vs. I_C

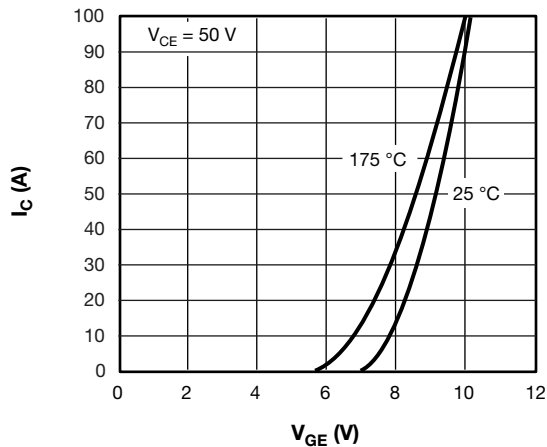


Fig. 2 - IGBT Transfer Characteristics

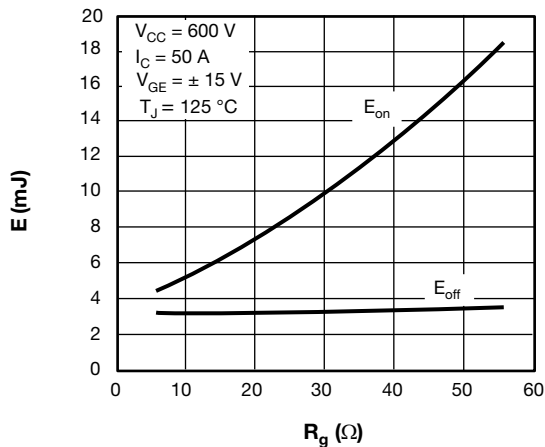


Fig. 4 - IGBT Switching Loss vs. R_g

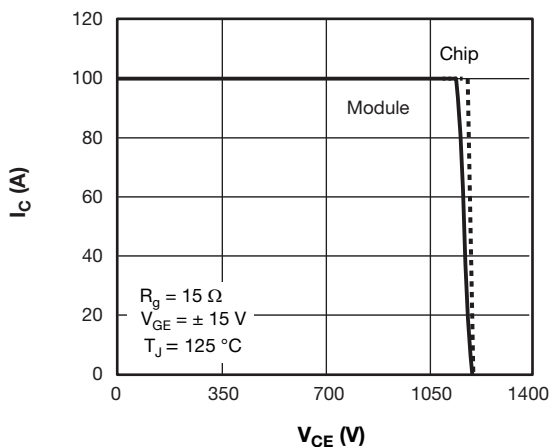


Fig. 5 - RBSOA

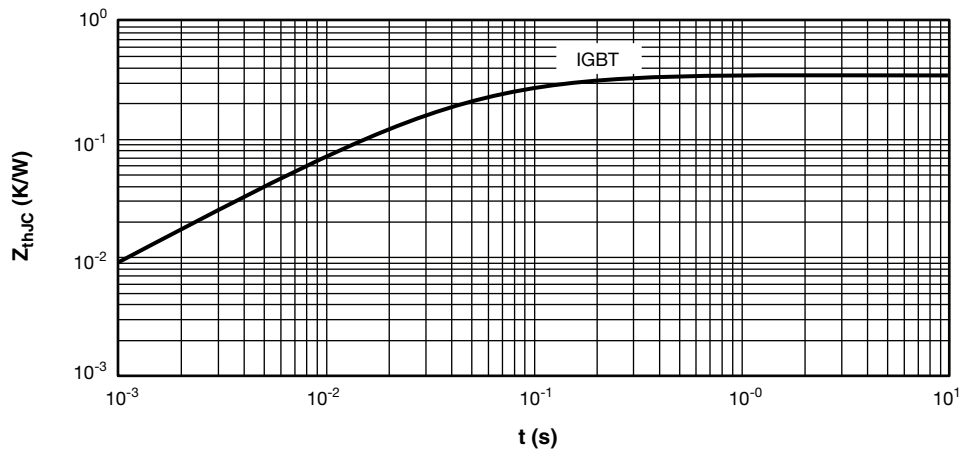


Fig. 6 - IGBT Transient Thermal Impedance

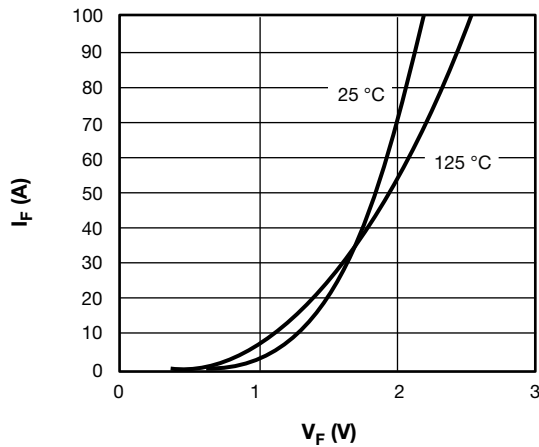


Fig. 7 - Diode Forward Characteristics

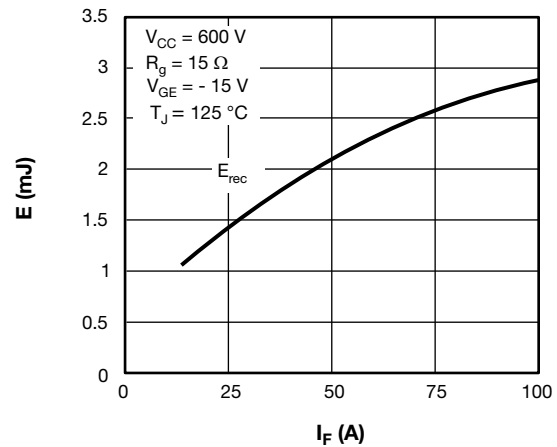


Fig. 8 - Diode Switching Loss vs. I_F

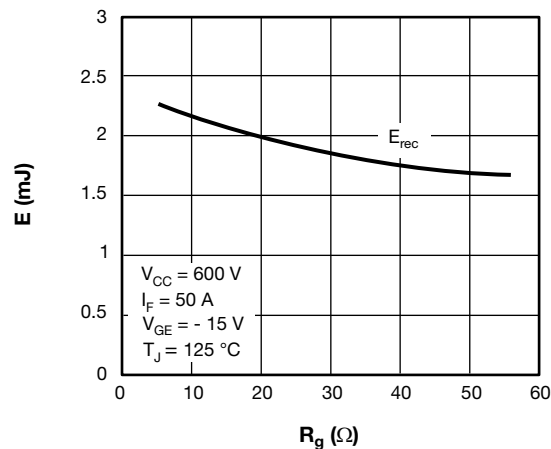


Fig. 9 - Diode Switching Loss vs. R_G

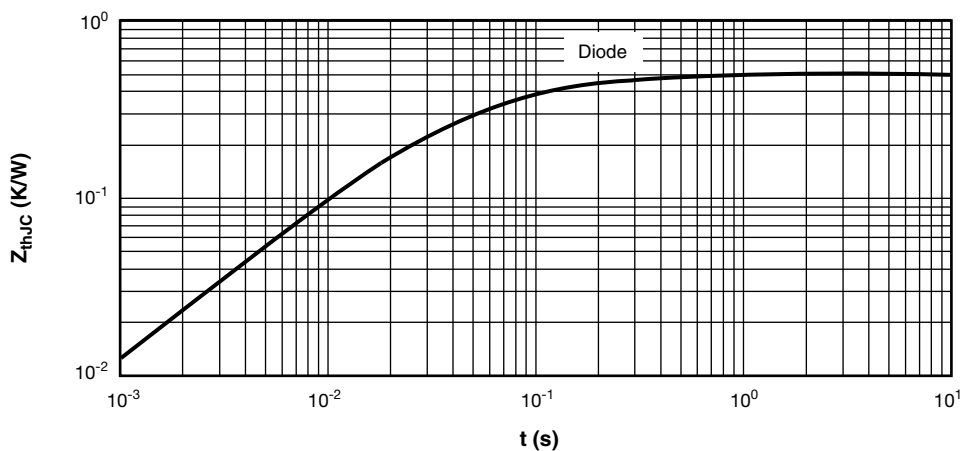
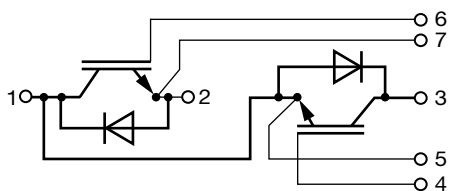


Fig. 10 - Diode Transient Thermal Impedance

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95524



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